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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









ES2A/A - ES2D/A

2.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony)

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.064 grams (approximate)
- SMB Weight: 0.093 grams (approximate)





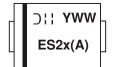
Ordering Information (Note 3)

| Part Number | Case | Packaging |
|-------------|------|------------------|
| ES2xA-13-F | SMA | 5000/Tape & Reel |
| ES2x-13-F | SMB | 3000/Tape & Reel |

^{*} x = Device type, e.g. ES2BA-13-F (SMA package); ES2A-13-F (SMB package).

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



ES2XA = Product type marking code, ex: ES2BA (SMA package) ES2X = Product type marking code, ex: ES2A (SMB package) □ = Manufacturers' code marking

YWW = Date code marking Y = Last digit of year (ex: 2 for 2002) WW = Week code (01 to 53)



Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

| Characteristic | Symbol | ES2A/A | ES2B/A | ES2C/A | ES2D/A | Unit |
|---|--|--------|--------|--------|--------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 4) | $egin{array}{c} egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}$ | 50 | 100 | 150 | 200 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 35 | 70 | 105 | 140 | V |
| Average Rectified Output Current @ T _T = 110°C | Ю | | 2 | .0 | | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half Sine-Wave Superimposed on Rated Load | I _{FSM} | | 5 | 0 | | Α |

Thermal Characteristics

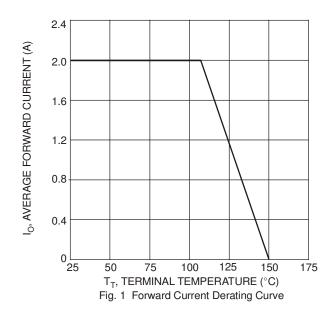
| Characteristic | Symbol | Value | Unit |
|---|-----------------------------------|-------------|------|
| Typical Thermal Resistance, Junction to Terminal (Note 5) | $R_{\theta JT}$ | 20 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

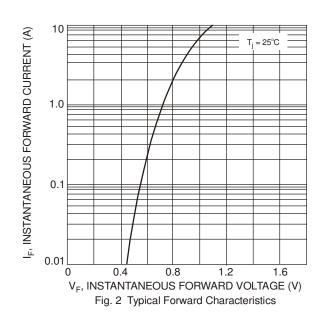
Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | | Symbol | Value | Unit |
|---------------------------------------|--------------------------|-----------------|-------|------|
| Forward Voltage | @ $I_F = 2.0A$ | V_{FM} | 0.92 | V |
| Peak Reverse Current | @ T _A = 25°C | lau | 5.0 | |
| at Rated DC Blocking Voltage (Note 4) | @ T _A = 125°C | I _{RM} | 350 | μА |
| Typical Total Capacitance (Note 6) | | C _T | 25 | рF |
| Reverse Recovery Time (Note 7) | | t _{rr} | 25 | ns |

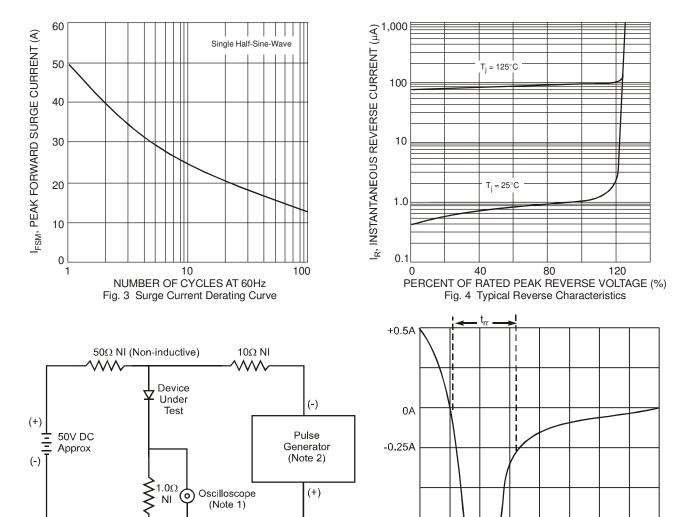
Notes:

- 4. Short duration pulse test used to minimize self-heating effect.
- F. Silor total attorn pulse test used to fill fill pulse self-reading effect. So Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink. 6. Measured at 1.0MHz and applied reverse voltage of 4.0V DC. 7. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$. See Figure 5.







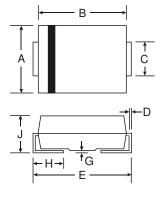


- Notes:
- 1. Rise Time = 7.0ns max. Input Impedance = $1.0M\Omega$, 22pF.
- 2. Rise Time = 10ns max. Input Impedance = 50Ω .

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

-1.0A

Package Outline Dimensions



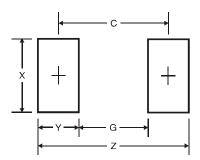
| | SMA | | | | | |
|---------|----------------------|------|--|--|--|--|
| Dim | Min | Max | | | | |
| Α | 2.29 | 2.92 | | | | |
| В | 4.00 | 4.60 | | | | |
| С | 1.27 | 1.63 | | | | |
| D | 0.15 | 0.31 | | | | |
| Е | 4.80 | 5.59 | | | | |
| G | 0.05 | 0.20 | | | | |
| Н | 0.76 | 1.52 | | | | |
| J | 2.01 | 2.30 | | | | |
| All Dim | All Dimensions in mm | | | | | |

| SMR | | | | |
|----------------------|------|------|--|--|
| Dim | Min | Max | | |
| Α | 3.30 | 3.94 | | |
| В | 4.06 | 4.57 | | |
| С | 1.96 | 2.21 | | |
| D | 0.15 | 0.31 | | |
| E | 5.00 | 5.59 | | |
| G | 0.05 | 0.20 | | |
| Н | 0.76 | 1.52 | | |
| J | 2.00 | 2.50 | | |
| All Dimensions in mm | | | | |

Set time base for 50/100 ns/cm



Suggested Pad Layout



| n mm) |
|-------|
| j |
| i |
| , |
| j |
| |
| |

| SMB Dimensions | Value (in mm) |
|-------------------|---------------|
| Z | 6.7 |
| G | 1.8 |
| Х | 2.3 |
| Υ | 2.5 |
| С | 4.3 |

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